

Engineering Development Model

Voltage Controlled Oscillator

MOS-EDR5867

Important Note

This model has been designed, built and tested in our engineering department. Performance data represents model capability. At present it is a non-catalog model. On request, we can supply a final specification sheet, part number and price/delivery information.



CASE STYLE : CZ682

Please click "Back", and then click "Contact Us" for Applications support.

ELECTRICAL SPECIFICATIONS 50Ω				
Parameter	Min.	Typ.	Max.	Units
Frequency	1980		2119	MHz
Tuning Voltage	0.5		6.5	V
Power Output		+0.5		dBm
Phase Noise				
at 1 kHz offset		-81		dBc/Hz
at 10 KHz offset		-105		dBc/Hz
at 100 KHz offset		-125		dBc/Hz
at 1000 kHz offset		-142		dBc/Hz
Pulling at 12 dBm PK-PK all phases		1.5		MHz
Pushing at Vcc=5V±0.25V		0.5		MHz/V
Tuning Sensitivity		24 - 32		MHz/V
Harmonic Suppression		-25	-14	dBc
3 dB Modulation Bandwidth		12000		kHz
Supply Voltage		5		V
Supply Current			30	mA

MAXIMUM RATINGS	
Operating Temperature	-55°C to 85°C
Storage Temperature	-55°C to 100°C
Absolute Supply Voltage (Vcc)	+7V
Absolute Tuning Voltage (Vtune)	+8.5V

PIN CONNECTIONS	
RF OUT	10
VCC	14
V-TUNE	1
GROUND	2,4,6,7,8

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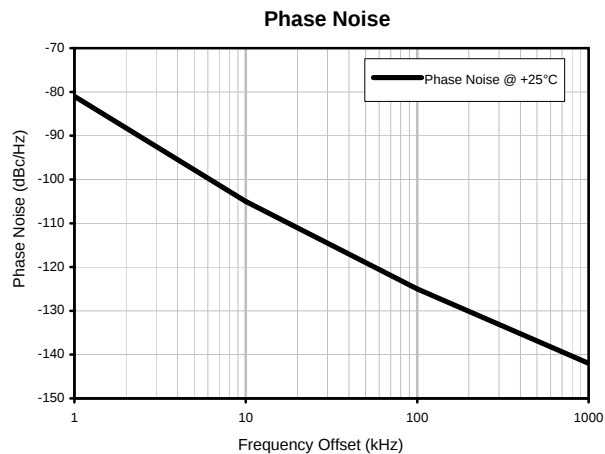
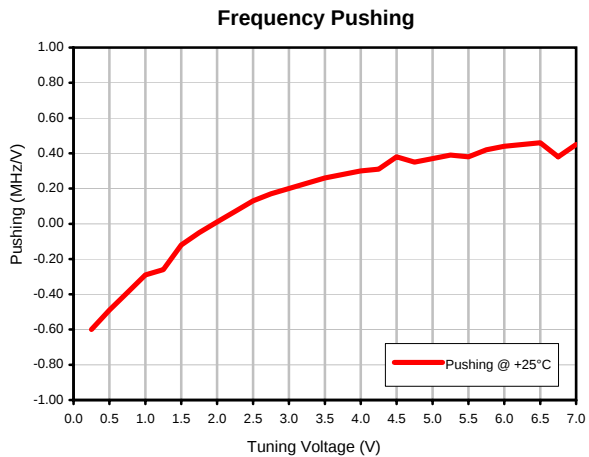
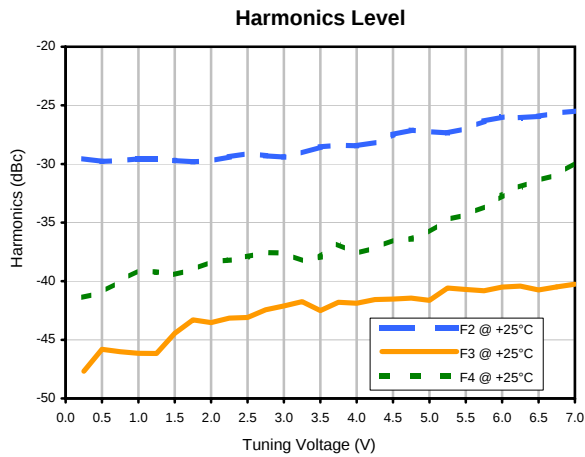
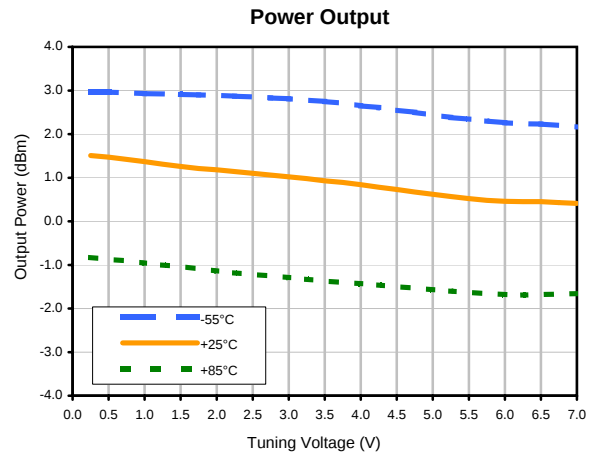
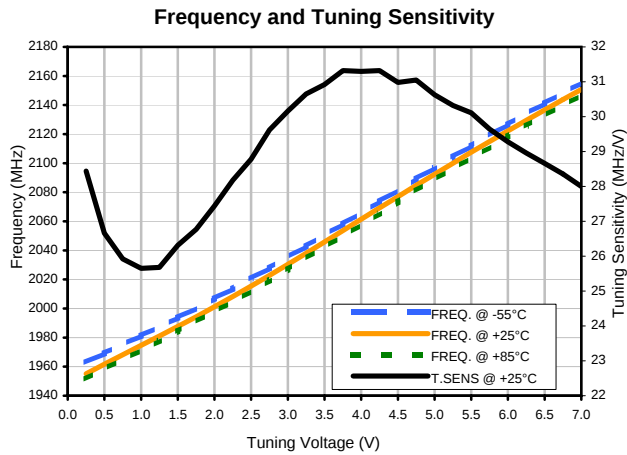
Typical Performance Data

V TUNE	TUNE SENS (MHz/V)	FREQUENCY (MHz)			POWER OUTPUT (dBm)			HARMONICS (dBc)			FREQ. PUSH (MHz/V)	FREQ OFFSET (KHz)	PHASE NOISE (dBc/Hz)
		-55°C	+25°C	+85°C	-55°C	+25°C	+85°C	F2	F3	F4			
0.3	28.44	1963.0	1955.1	1951.6	2.96	1.51	-0.83	-29.6	-47.7	-41.4	-0.60	1	-81
0.5	26.66	1969.2	1961.7	1958.4	2.96	1.47	-0.87	-29.8	-45.8	-41.0	-0.49	10	-105
0.8	25.92	1975.2	1968.2	1964.9	2.95	1.42	-0.91	-29.7	-46.0	-40.0	-0.39	100	-125
1.0	25.65	1981.3	1974.6	1971.4	2.93	1.37	-0.96	-29.6	-46.2	-39.1	-0.29	1000	-142
1.3	25.68	1987.5	1981.1	1977.9	2.92	1.31	-1.00	-29.6	-46.2	-39.2	-0.26		
1.5	26.31	1993.7	1987.6	1984.4	2.91	1.26	-1.04	-29.7	-44.4	-39.4	-0.12		
1.8	26.77	2000.2	1994.3	1991.0	2.90	1.21	-1.09	-29.8	-43.3	-39.0	-0.05		
2.0	27.44	2006.8	2001.2	1997.8	2.89	1.18	-1.14	-29.7	-43.5	-38.3	0.01		
2.3	28.18	2013.6	2008.2	2004.8	2.87	1.14	-1.18	-29.4	-43.2	-38.2	0.07		
2.5	28.78	2020.6	2015.4	2012.0	2.85	1.10	-1.22	-29.1	-43.1	-37.9	0.13		
2.8	29.62	2027.9	2022.8	2019.3	2.83	1.06	-1.25	-29.3	-42.4	-37.6	0.17		
3.0	30.16	2035.3	2030.4	2026.8	2.81	1.02	-1.29	-29.4	-42.1	-37.6	0.20		
3.3	30.65	2042.8	2038.0	2034.4	2.78	0.98	-1.33	-29.1	-41.7	-38.3	0.23		
3.5	30.92	2050.5	2045.8	2042.2	2.75	0.93	-1.37	-28.5	-42.5	-37.9	0.26		
3.8	31.32	2058.2	2053.6	2049.9	2.71	0.89	-1.40	-28.4	-41.8	-36.9	0.28		
4.0	31.30	2065.9	2061.4	2057.7	2.65	0.84	-1.43	-28.5	-41.9	-37.6	0.30		
4.3	31.32	2073.7	2069.2	2065.5	2.61	0.78	-1.46	-28.2	-41.6	-37.2	0.31		
4.5	30.98	2081.4	2077.0	2073.3	2.55	0.73	-1.50	-27.5	-41.5	-36.5	0.38		
4.8	31.05	2089.2	2084.8	2081.0	2.50	0.67	-1.53	-27.1	-41.4	-36.4	0.35		
5.0	30.63	2096.8	2092.4	2088.7	2.44	0.62	-1.57	-27.2	-41.6	-35.8	0.37		
5.3	30.32	2104.3	2100.0	2096.2	2.38	0.57	-1.60	-27.4	-40.6	-34.7	0.39		
5.5	30.11	2111.9	2107.5	2103.7	2.34	0.52	-1.63	-27.0	-40.7	-34.3	0.38		
5.8	29.64	2119.2	2114.9	2111.1	2.30	0.48	-1.66	-26.3	-40.8	-33.6	0.42		
6.0	29.28	2126.6	2122.2	2118.4	2.26	0.46	-1.68	-26.0	-40.5	-32.7	0.44		
6.3	28.96	2133.9	2129.5	2125.6	2.24	0.45	-1.69	-26.0	-40.4	-32.0	0.45		
6.5	28.66	2141.1	2136.7	2132.7	2.23	0.45	-1.68	-25.9	-40.7	-31.4	0.46		
6.8	28.36	2148.3	2143.7	2139.8	2.20	0.43	-1.67	-25.7	-40.5	-30.9	0.38		
7.0	28.00	2155.4	2150.7	2146.7	2.16	0.41	-1.66	-25.5	-40.3	-29.9	0.45		

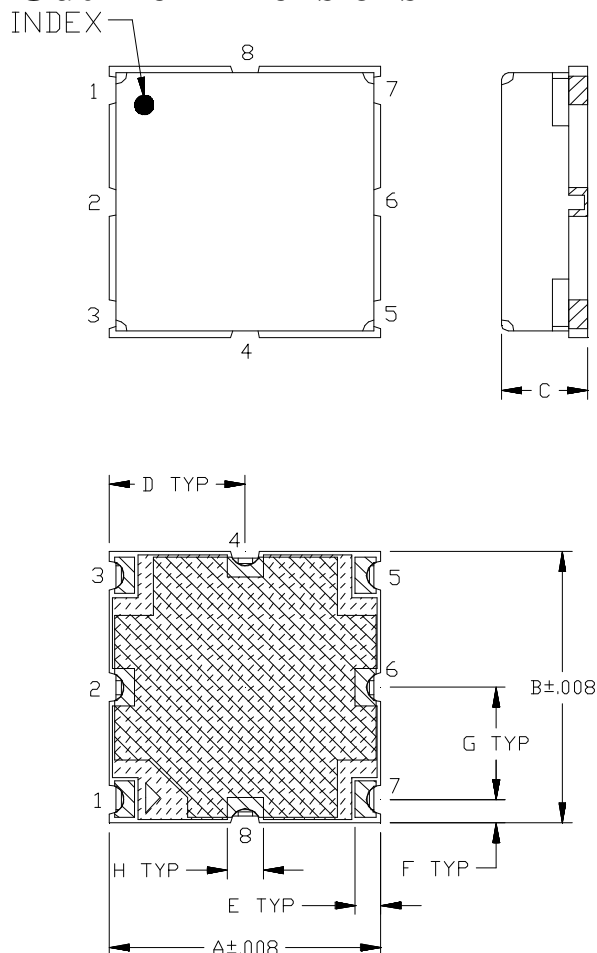
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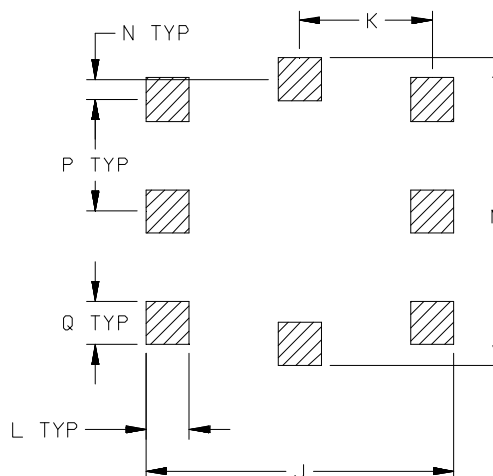
Typical Performance Data



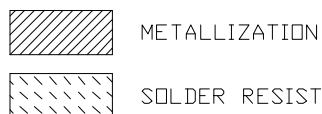
Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm.002$



CASE #	A	B	C	D	E	F	G	H	J	K
CZ682	.375 (9.52)	.375 (9.52)	.131 (3.33)	.188 (4.77)	.035 (0.89)	.033 (0.84)	.154 (3.91)	.050 (1.27)	.425 (10.80)	.183 (4.65)

CASE #	L	M	N	P	Q	WT. GRAM
CZ682	.060 (1.52)	.425 (10.80)	.028 (0.71)	.154 (3.91)	.060 (1.52)	.60

Dimensions are in inches (mm). Tolerances: 2Pl. $\pm .03$; 3Pl. $\pm .010$

Notes:

1. Case material: Nickel-Silver alloy.
2. Base: Printed wiring laminate.
3. Termination finish:

For RoHS Case Styles: 3-5 μ inch (.08-.13 microns) Gold over 120-240 μ inch (3.05-6.10 microns) Nickel plate
For RoHS-5 Case Styles: Tin-Lead plate.



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Mini-Circuits ISO 9001 & ISO 14001 Certified

Tape & Reel Packaging TR-F60



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
24	16	7	Small quantity standards (see note)	10
				20
				50
				100
		13	Standard	200
				500
				1000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



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THIRD ANGLE PROJECTION



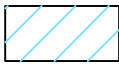
REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M76040	NEW RELEASE (FROM RAVON)	03/01	DK	HH
A	M82575	UPDATED DRAWING	08/08/02	GF	MM
B	M101142	ADDED NOTE 2 & TB-128 TO DESCRIPTION	10/10/05	MMG	MM
C	M102713	ADDED "...WITH SMOBC"	01/12/06	GF	IL

SUGGESTED MOUNTING CONFIGURATION FOR CZ682 CASE STYLE, "my" PIN CONNECTION



- NOTE: 1. TRACE WIDTH IS SHOWN FOR FR4 WITH DIELECTRIC THICKNESS $0.030" \pm 0.002"$; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

 DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
 DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

DRAWN

DK (RAV)

03/22/01

TOLERANCES ON:

CHECKED

DE (RAV)

03/27/01

2 PL DECIMALS $\pm$

APPROVED

HH (RAV)

03/27/01

3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$
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ASHEETA1.DWG REV:A DATE:01/12/95


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Brooklyn NY 11235

PL, my, CZ682, MOS, TB-128

 SIZE
A

 CODE IDENT
15542

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98-PL-023

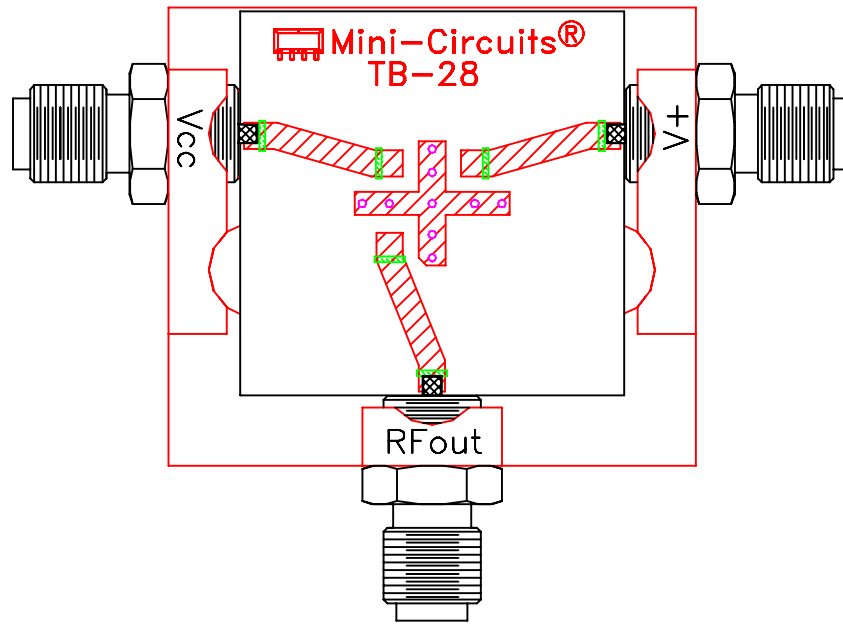
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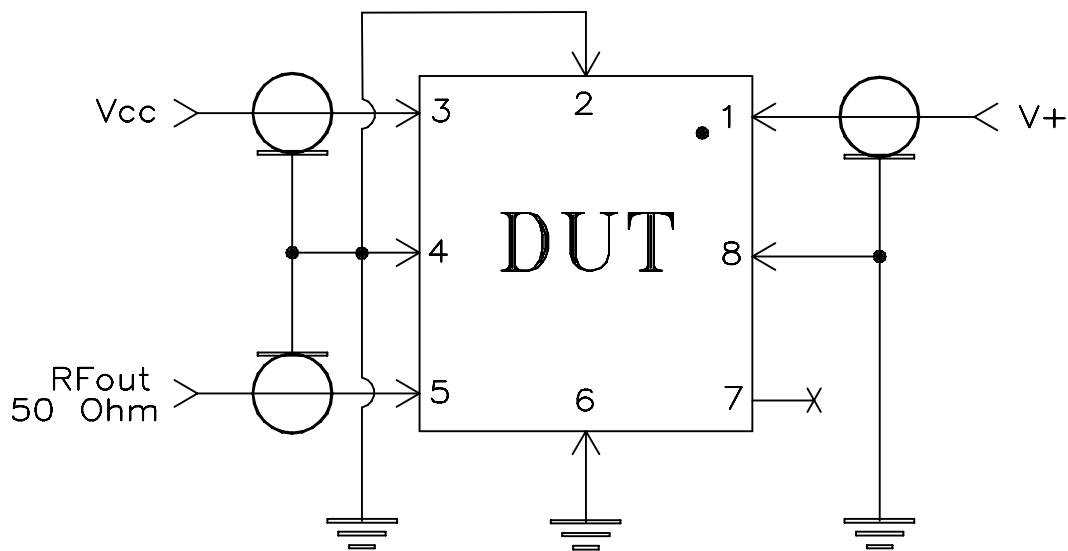
SCALE: 5:1

SHEET: 1 OF 1

Evaluation Board and Circuit



TB-28



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

 Mini-Circuits®



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
HAST	130°C, 85% RH, 96 hours	JESD22-A110
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutectic Process: 225°C peak Pb-Free Process, 245°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 20-2000 Hz, 4 times in each of three axes (total 12)	MIL-STD-883, Method 2007.3, Condition A
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215